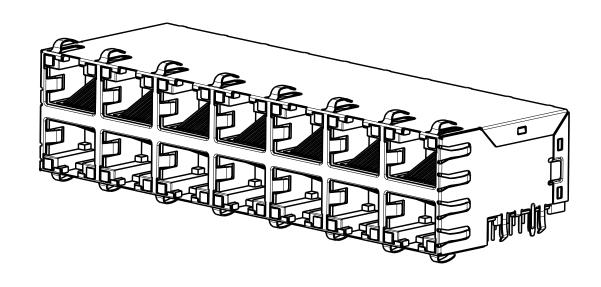
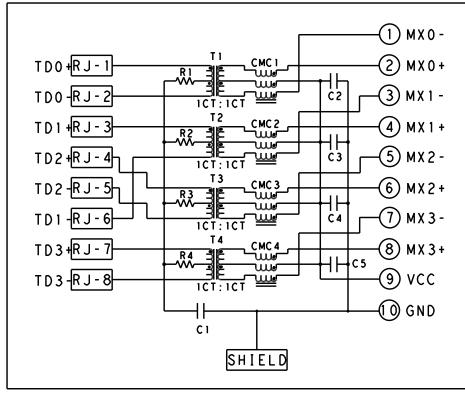
1



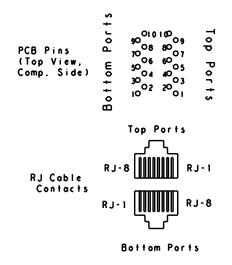
S8G16 GIGABIT CIRCUIT AA

Top and Bottom Ports



C1 = 1000 pF, 2kV C2-C5 = 470pF, 10%, 50V R1-R4 = 75 Ohm, 1/16W

Pin Designations (Repeat for each vertical pair of ports.)



⚠ MATERIALS:

- HOUSING: THERMOPLASTIC, BLACK, FLAMMABILITY RATING UL 94V-0.
 SHIELD: BRASS, PREPLATED WITH 0.76um MIN SEMI-BRIGHT NICKEL,
- POST DIPPED WITH 2.54um MIN SAC SOLDER ON SOLDER TAILS.
 CONTACTS: PHOSPHOR BRONZE, PLATED WITH 1.27um MIN OVERALL
- NICKEL UNDERPLATE, SELECTIVE 1.27um MIN GOLD AT MATING INTERFACE AND 2.54um MIN MATTE TIN ON SOLDER TAILS.

2

- LED: DIFFUSED EPOXY LENS, CARBON STEEL LEAD FRAME LEADS, PREPLATED WITH 2.03um MIN SILVER OVER 1.02um MIN NICKEL OVER 1.02um MIN COPPER UNDERPLATE, POST PLATED WITH 2.54um MIN MATTE TIN AND/OR 2.54um MIN SAC SOLDER DIP OR PURE TIN SOLDER DIP.

A MAGNETICS:

- APPLICATION: 10/100/1000 BASE-T
- IMPEDANCE: 100ohms

3

- TURNS RATIO (CHIP:CABLE): 1:1 ALL FOUR PAIRS
- OPEN CIRCUIT INDUCTANCE (OCL): 350uH MIN @100kHz, 0.1VRMS,
- 8mA DC BIAS FROM 0°C TO 70°C, ALL FOUR PAIRS
- ALL FOUR PAIRS BI-DIRECTIONAL
- PERFORMANCE @25°C:

INSERTION LOSS (IL): 1.1dB MAX FROM 0.5MHz TO 100MHz RETURN LOSS (RL): 18dB MIN FROM 0.5MHz TO 40MHz

12-20LOG([/80]dB MIN FROM 40.1MHz TO 100MHz

CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 40MHz

33-20LOG((/50)dB MIN FROM 40.1MHz TO 100MHz COMMON MODE REJECTION RATIO (CMRR):

30dB MIN FROM 0.5MHz TO 100MHz

- DIELECTRIC (ISOLATION VOLTAGE): 2250 VDC(MAX) FOR 60 SECS WITH RISE TIME OF 500V/SEC AND WITH ALL PORTS CONNECTED.

APPROXIMATE AREA SHOWN. DATE CODE: YYWWD WHERE YY IS YEAR, WW IS WORK WEEK. D IS DAY OF WEEK. WITH SUNDAY=1.

TRP LOGO AND AGENCY APPROVAL LOGO ARE LOCATED IN THE APPROXIMATE AREA SHOWN.

A RJ45 CAVITIES CONFORM TO FCC RULES AND REGULATIONS PART 68 SUBPART F.

LED IS DRIVEN WITH CONSTANT CURRENT AT APPROX 20mA LED COLOR: DOMINANT WAVELENGTH (λD): GREEN 568 nm TYP at IF=20mA FORWARD VOLTAGE (VF): GREEN 2.2V TYP at IF=20mA

⚠ INDICATED MAGNETIC CONNECTIONS ARE SYMMETRICAL AND SUPPORT AUTO-MDI/MDIX.

- 8 OPERATING TEMPERATURE: FROM 0°C TO 70°C
- 9 THE PARTS ARE RECOMMENDED FOR WAVE SOLDERING PROCESS, PEAK TEMPERATURE 260 °C MAX. 10 SECONDS MAX.IT IS RECOMMENDED THAT THE CONNECTOR SHIELD AND BODY BE MASKED TO PROTECT IT FROM DIRECT EXPOSURE TO THE SOLDER WAVE TO AVOID DAMAGE TO THE CONNECTOR AND LEDS.

GREEN	GREEN	GREEN	GREEN	1840936-1
BOTTOM LED 2 (LEFT)	BOTTOM LED 1 (RIGHT)	TOP LED 2 (LEFT)	TOP LED 1 (RIGHT)	PART NUMBER
THIS DRAWING IS A CO	TOLERANCES UNLESS OTHERWISE SPECIFIED: APVD	26MAR2010 PAN 26MAR2010 US CHEN 26MAR2010	trp conne	CTOR DONGGUAN
$\oplus \boxminus$	D PLC ±- PLC ±- PLC ±0, 25 PLC ±0, 25 PLC ±- PLC ±-	MAGJACK SIZE CAG	7 S8G16 GIGABIT OF	FSET W/ LED
	APPLICATION SPEC 51/	ACK NON-POE A 1	C-1840936	HEET I OF A REV 6

